

High-current Gain Medium Power Transistor (20V, 0.5A) 2SD2114K

Features

1) High DC current gain. $h_{FE} = 1200 (Typ.)$

2) High emitter-base voltage. VEBO =12V (Min.)

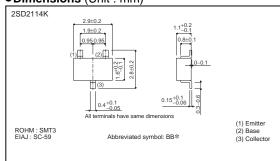
3) Low VCE (sat).

 $V_{CE (sat)} = 0.18V (Typ.)$ (Ic / IB = 500mA / 20mA)

Structure

Epitaxial planar type NPN silicon transistor

● Dimensions (Unit: mm)



* Denotes hre

●Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit
Collector-base voltage	Vсво	25	V
Collector-emitter voltage	Vceo	20	V
Emitter-base voltage	VEBO	12	V
Collector current	Ic	0.5	A(DC)
		1	A(Pulse) *
Collector power dissipation	Pc	0.2	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

^{*} Single pulse Pw=100ms

●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Collector-base breakdown voltage	ВУсво	25	_	_	V	Ic=10μA
Collector-emitter breakdown voltage	BVceo	20	_	_	V	Ic=1mA
Emitter-base breakdown voltage	ВУЕВО	12	_	_	V	Iε=10μA
Collector cutoff current	Ісво	_	_	0.5	μΑ	Vcb=20V
Emitter cutoff current	ІЕВО	_	_	0.5	μΑ	V _{EB} =10V
Collector-emitter saturation voltage	VCE(sat)	_	0.18	0.4	V	Ic/I _B =500mA/20mA
DC current transfer ratio	hfe	820	_	2700	_	Vce=3V, Ic=10mA
Transition frequency	f⊤*	-	350	_	MHz	Vce=10V, Ie= -50mA, f=100MHz
Output capacitance	Cob	-	8.0	_	pF	Vcb=10V, Ie=0A, f=1MHz
Output On-resistance	Ron	_	0.8	_	Ω	I _B =1mA, Vi=100mV(rms), f=1kHz

^{*} Measured using pulse current

2SD2114K Data Sheet

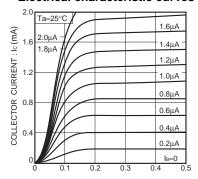
Packaging specifications and hfe

		Package	Taping
		Code	T146
Туре	h _{FE}	Basic ordering unit (pieces)	3000
2SD2114K	VW		0

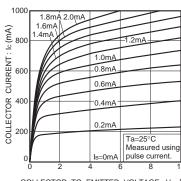
hre values are classified as follows:

Item	V	W	
hfE	820 to 1800	1200 to 2700	

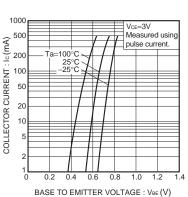
•Electrical characteristic curves



COLLECTOR TO EMITTER VOLTAGE: VcE(V)



COLLECTOR TO EMITTER VOLTAGE : $V_{CE}(V)$



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Fig.1 Grounded emitter output characteristics (I)

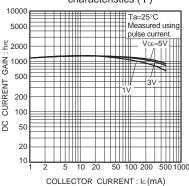


Fig.4 DC current gain vs. collector current (I)

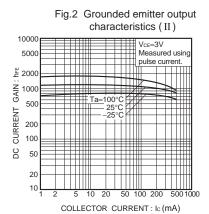


Fig.5 DC current gain vs. collector current (II)

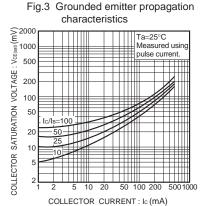


Fig.6 Collector-emitter saturation voltage vs. collector current (I)

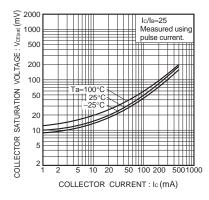


Fig.7 Collector-emitter saturation voltage vs. collector current (II)

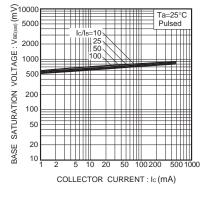


Fig.8 Base-emitter saturation voltage vs. collector current (I)

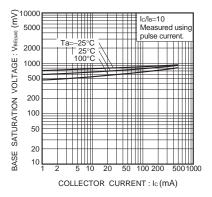


Fig.9 Base-emitter saturation voltage vs. collector current ($\rm II$)

2SD2114K Data Sheet

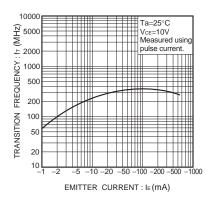


Fig.10 Gain bandwidth product vs. emitter current

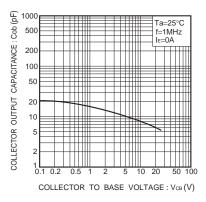


Fig.11 Collector output capacitance vs. collector-base voltage

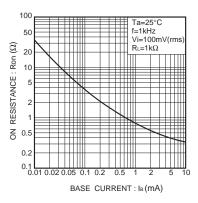
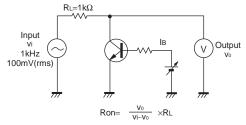


Fig.12 Output-on resistance vs. base current

●Ron measurement circuit



Notes

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